

PROCEEDINGS OF SPIE

Behavior and Mechanics of Multifunctional Materials and Composites 2017

Nakhiah C. Goulbourne

Editor

26–28 March 2017

Portland, Oregon, United States

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SPIE

Volume 10165

Proceedings of SPIE 0277-786X, V. 10165

SPIE is an international society advancing an interdisciplinary approach to the science and application of light.

Behavior and Mechanics of Multifunctional Materials and Composites 2017, edited by Nakhiah C. Goulbourne,
Proc. of SPIE Vol. 10165, 1016501 · © 2017 SPIE · CCC code: 0277-786X/17/\$18 · doi: 10.1117/12.2270662

Proc. of SPIE Vol. 10165 1016501-1

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Author(s), "Title of Paper," in *Behavior and Mechanics of Multifunctional Materials and Composites 2017*, edited by Nakhiah C. Goulbourne, Proceedings of SPIE Vol. 10165 (SPIE, Bellingham, WA, 2017) Seven-digit Article CID Number.

ISSN: 0277-786X
ISSN: 1996-756X (electronic)

ISBN: 9781510608153
ISBN: 9781510608160 (electronic)

Published by

SPIE

P.O. Box 10, Bellingham, Washington 98227-0010 USA
Telephone +1 360 676 3290 (Pacific Time) · Fax +1 360 647 1445
SPIE.org

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